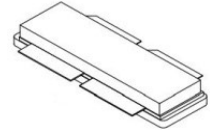




## 2.4-2.5Hz, 32V 300W, High Power RF LDMOS FETs

### ITCH25280D4



#### Description

The ITCH25280D4 is a 300-watt, internally matched LDMOS FETs, designed for Multiple use especially RF Energy application including cooking, heating and medical with frequencies from 2400 to 2500 MHz.

- Typical Performance (on Innogrations fixture with device soldered): Tcase=25 Degree C

Freq	P1dB	P1dB	P1dB Eff	P1dB Gain	P3dB	P3dB	P3dB Eff
(MHz)	(dBm)	(W)	%	dB	(dBm)	(W)	%
2400	55.39	345.87	58.47	15.26	55.74	375.12	59
2450	55.20	331.08	58.21	15.48	55.59	362.56	58.5
2500	54.60	288.47	56.74	15.62	55.27	336.52	58

#### Features

- High Efficiency and Linear Gain Operations
- Integrated ESD Protection
- Internally Matched for Ease of Use
- Large Positive and Negative Gate/Source Voltage Range for Improved Class C Operation
- Excellent thermal stability, low HCI drift
- Compliant to Restriction of Hazardous Substances (RoHS) Directive 2002/95/EC

**Table 1. Maximum Ratings**

Rating	Symbol	Value	Unit
Drain--Source Voltage	V <sub>DSS</sub>	70	Vdc
Gate--Source Voltage	V <sub>GS</sub>	-10 to +10	Vdc
Operating Voltage	V <sub>DD</sub>	+32	Vdc
Storage Temperature Range	T <sub>stg</sub>	-65 to +150	°C
Case Operating Temperature	T <sub>c</sub>	+150	°C
Operating Junction Temperature	T <sub>j</sub>	+225	°C

**Table 2. Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Thermal Resistance, Junction to Case Tcase= 85°C, Pout=300W CW	R <sub>θJC</sub>	0.2	°C/W

**Table 3. ESD Protection Characteristics**

Test Methodology	Class
Human Body Model (per JESD22--A114)	Class 2

**Table 4. Electrical Characteristics** (TA = 25 °C unless otherwise noted)

Characteristic	Symbol	Min	Typ	Max	Unit
----------------	--------	-----	-----	-----	------

#### DC Characteristics

Drain-Source Breakdown Voltage (V <sub>GS</sub> =0V; I <sub>D</sub> =100uA)	V <sub>DSS</sub>	65	---	---	V
--	------------------	----	-----	-----	---



Zero Gate Voltage Drain Leakage Current ( $V_{DS} = 28\text{ V}$ , $V_{GS} = 0\text{ V}$ )	$I_{loss}$	---	---	10	$\mu\text{A}$
Gate--Source Leakage Current ( $V_{GS} = 6\text{ V}$ , $V_{DS} = 0\text{ V}$ )	$I_{loss}$	---	---	1	$\mu\text{A}$
Gate Threshold Voltage ( $V_{DS} = 28\text{ V}$ , $I_D = 600\text{ uA}$ )	$V_{GS(th)}$	---	1.6	---	V
Gate Quiescent Voltage ( $V_{DD} = 32\text{ V}$ , $I_{DQ} = 20\text{ mA}$ , Measured in Functional Test)	$V_{GS(Q)}$	---	2.25	---	V

**Functional Tests (In Innogrations Test Fixture, 50 ohm system) :**  $V_{DD} = 32\text{ Vdc}$ ,  $I_{DQ} = 20\text{ mA}$ ,  $f = 2450\text{ MHz}$ , CW Signal Measurements.,  
Pin=12W,

Power Gain	$G_p$	---	14	---	dB
Drain Efficiency@Pout	$\eta_D$	---	58	---	%
Output Power	$P_{-3dB}$	300		---	W
Input Return Loss	IRL	---	-7	---	dB

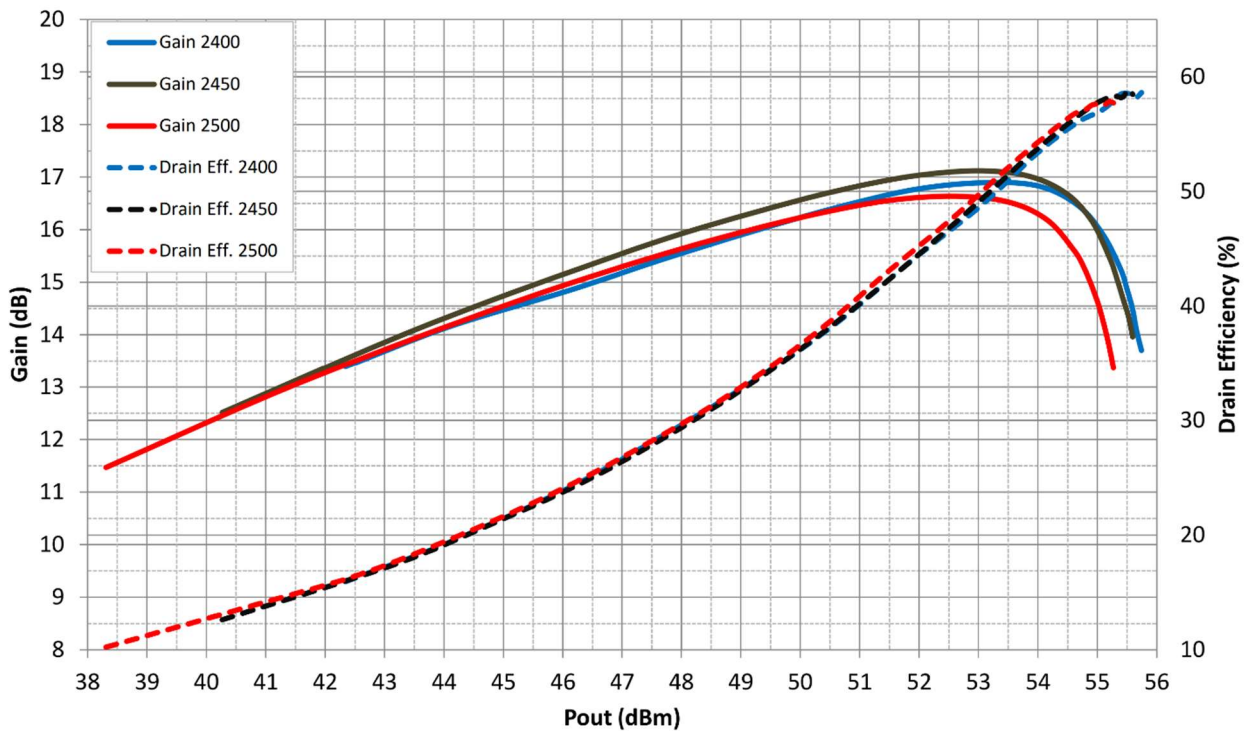
**Load Mismatch (In Innogrations Test Fixture, 50 ohm system):**  $V_{DD} = 32\text{ Vdc}$ ,  $I_{DQ} = 20\text{ mA}$ ,  $f = 2450\text{ MHz}$

VSWR 10:1 at 300W pulse CW Output Power	No Device Degradation
---	-----------------------

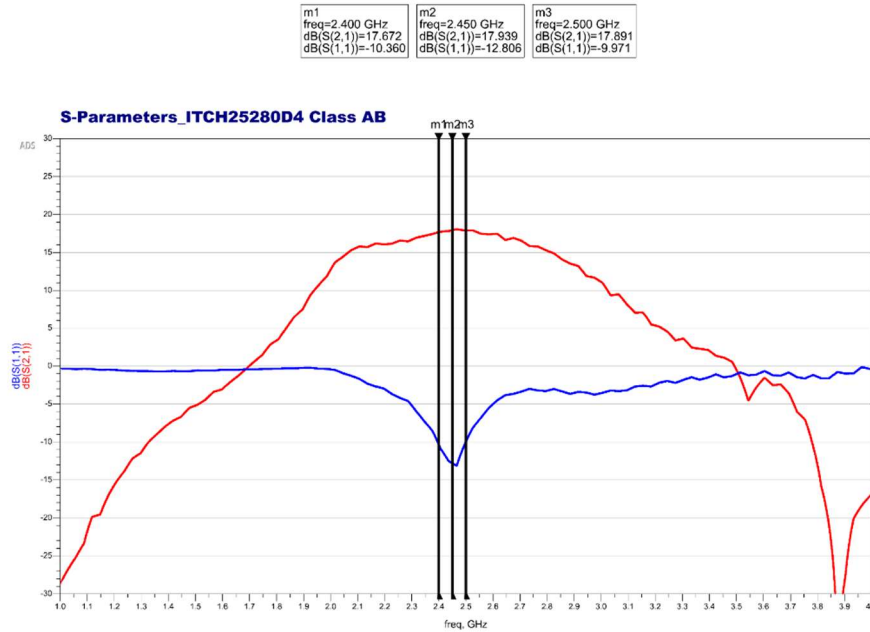
**Figure 1**

**Signal: Pulse width 20us, duty cycle 10%**

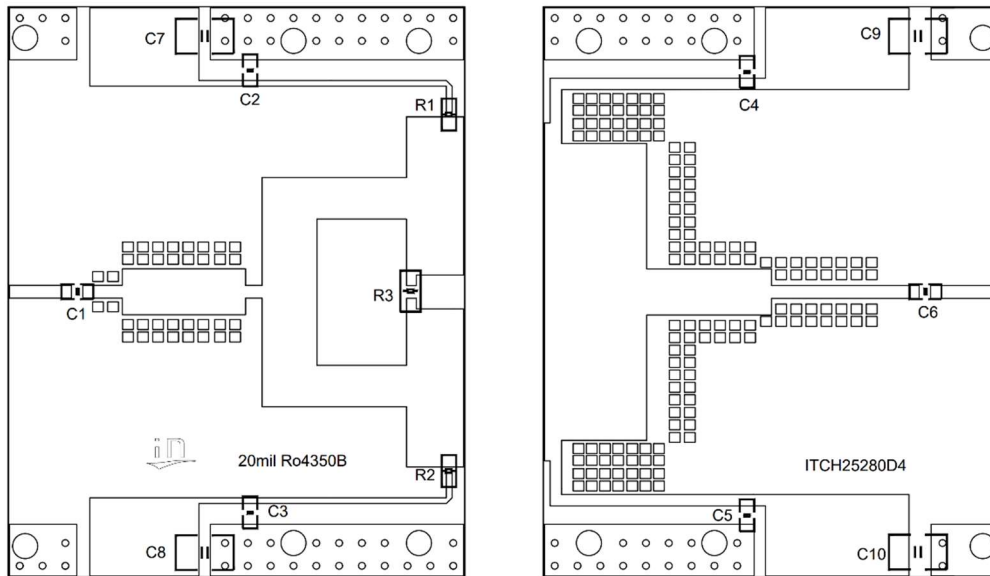
**Vgs= 2.25V, Vds= 32V, Idq=20mA**



**Figure 3. Network analyzer output S11/S21 (Vdd=32V, Idq=1500mA)**



**Reference Circuit of Test Fixture Assembly Diagram**



**Figure 1. Test Circuit Component Layout**

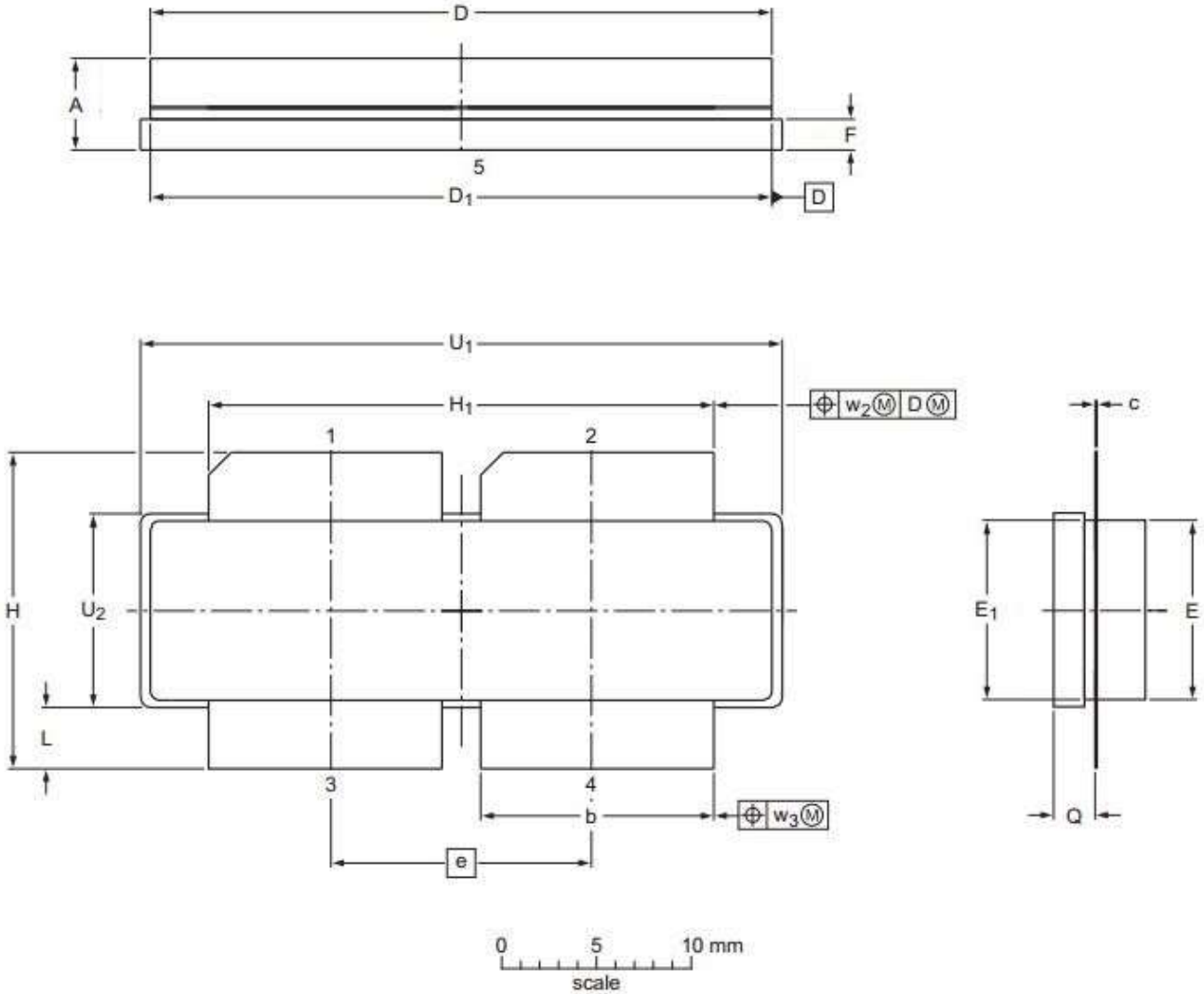
**Table 1. Test Circuit Component Designations and Values**

Reference	Footprint	Value	Quantity
C1, C2, C3, C4, C5, C6	0603	8.2pF/250V	6
R1, R2	0603	10R	2
R3	1206	10R	1
C7, C8, C9, C10	1210	10uF/100V	4
U1	D4	ITCH25280D4	1



### Package Outline

Earless flanged ceramic package; 4 leads (1、2—DRAIN、3、4—GATE、5—SOURCE)



UNIT	A	b	c	D	D <sub>1</sub>	e	E	E <sub>1</sub>	F	H	H <sub>1</sub>	L	Q	U <sub>1</sub>	U <sub>2</sub>	W <sub>2</sub>	W <sub>2</sub>
mm	4.7	11.81	0.18	31.55	31.52	13.72	9.50	9.53	1.75	17.12	25.53	3.48	2.26	32.39	10.29	0.25	0.25
	4.2	11.56	0.10	30.94	30.96		9.30	9.27	1.50	16.10	25.27	2.97	2.01	32.13	10.03		
inches	0.185	0.465	0.007	1.242	1.241	0.540	0.374	0.375	0.069	0.674	1.005	0.137	0.089	1.275	0.405	0.01	0.01
	0.165	0.455	0.004	1.218	1.219		0.366	0.365	0.059	0.634	0.995	0.117	0.079	1.265	0.395		

OUTLINE VERSION	REFERENCE			EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA		
PKG-D4					03/12/2013



## Revision history

Table 5. Document revision history

Date	Revision	Datasheet Status
2023/9/27	V1	Preliminary Datasheet Creation

Application data based on ZBB-23-31

## Disclaimers

Specifications are subject to change without notice. Innogrations believes the information contained within this data sheet to be accurate and reliable. However, no responsibility is assumed by Innogrations for any infringement of patents or other rights of third parties which may result from its use. No license is granted by implication or otherwise under any patent or patent rights of Innogrations. Innogrations makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose. "Typical" parameters are the average values expected by Innogrations in large quantities and are provided for information purposes only. These values can and do vary in different applications and actual performance can vary over time. All operating parameters should be validated by customer's technical experts for each application. Innogrations products are not designed, intended or authorized for use as components in applications intended for surgical implant into the body or to support or sustain life, in applications in which the failure of the Innogrations product could result in personal injury or death or in applications for planning, construction, maintenance or direct operation of a nuclear facility. For any concerns or questions related to terms or conditions, pls check with Innogrations and authorized distributors

Copyright © by Innogrations (Suzhou) Co.,Ltd.